

## 25A,100V Schottky Barrier Rectifier

### Features

- Low leakage current
- Schottky barrier diode
- Low forward voltage drop
- Very low profile - typical height of 1.1 mm
- Moisture sensitivity: level 1, per J-STD-020
- Halogen-free according to IEC 61249-2-21 definition
- High temperature soldering guaranteed: 260°C/10 seconds



**RoHS**  
COMPLIANT



eSGC (TO-277B)

### Applications

For use of fast switching in RF module, lighting, cellular phone, portable device, power supplies and other consumer applications.

<b>Maximum Ratings &amp; Electrical Characteristics</b> (TA=25°C unless otherwise noted)			
Parameter	Symbol	SGC251BS	Unit
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	V
Maximum RMS voltage	V <sub>RMS</sub>	70	V
Maximum DC blocking voltage	V <sub>DC</sub>	100	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	25	A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>	250	A
Operating junction temperature range	T <sub>J</sub>	-55 to +150	°C
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C

<b>Thermal-Mechanical Specifications</b> (TA=25°C unless otherwise noted)			
Parameter	Symbol	Typ	Unit
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	40	°C/W
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	15	°C/W
Thermal Resistance, Junction to Lead	R <sub>θJL</sub>	7	°C/W

## Electrical Specifications (T<sub>A</sub>=25°C unless otherwise noted)

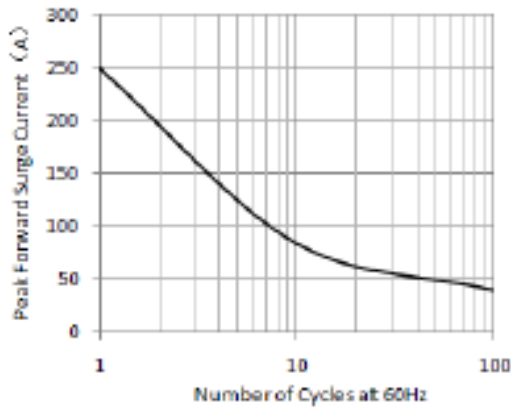
Parameter	Symbol	Test Conditions	Typ	Max	Unit
Forward drop voltage	V <sub>F</sub>	I <sub>F</sub> =2A	-	0.42	V
		I <sub>F</sub> =25A		0.70	
Reverse leakage current @V <sub>R</sub>	I <sub>R</sub>	T <sub>J</sub> =25°C	-	250	uA
		T <sub>J</sub> =100°C	-	30	mA
Typical junction capacitance	C <sub>J</sub>	4.0V 1 MHz	1780		pF

Note:

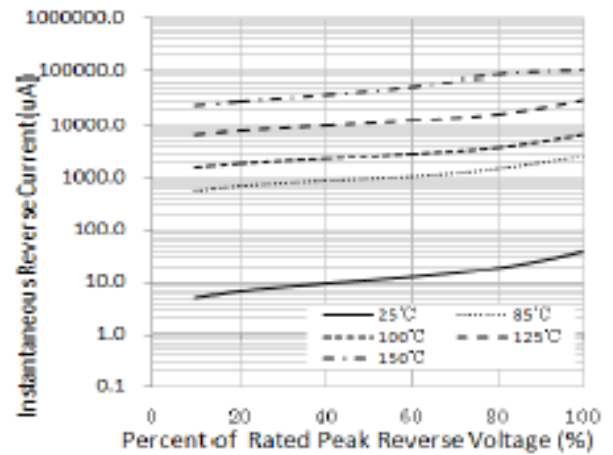
1. Mounted on copper pad area of 30 x 30mm to each terminal.

## Ratings and Characteristics Curves

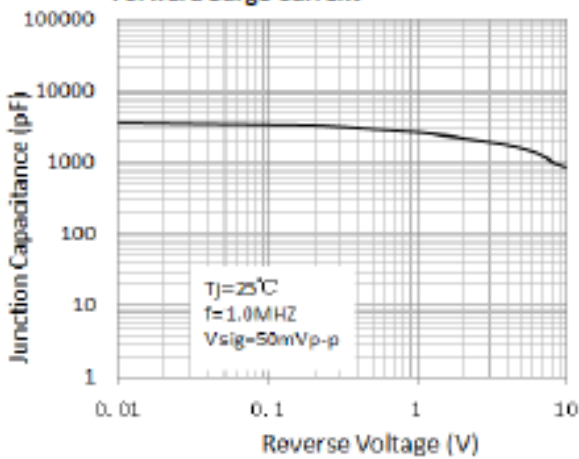
(TA = 25°C unless otherwise noted)



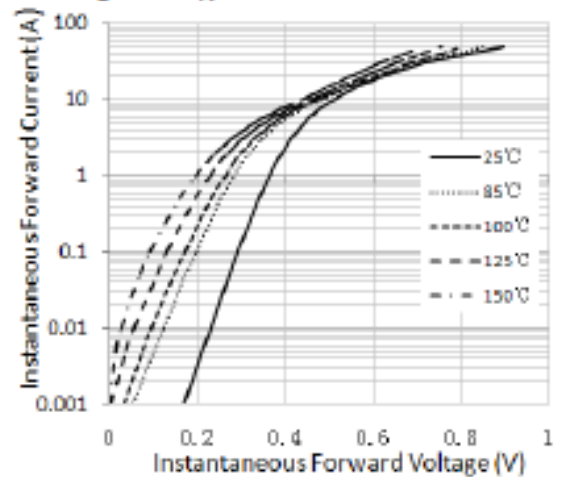
**Figure 1. Maximum Non-Repetitive Peak Forward Surge Current**



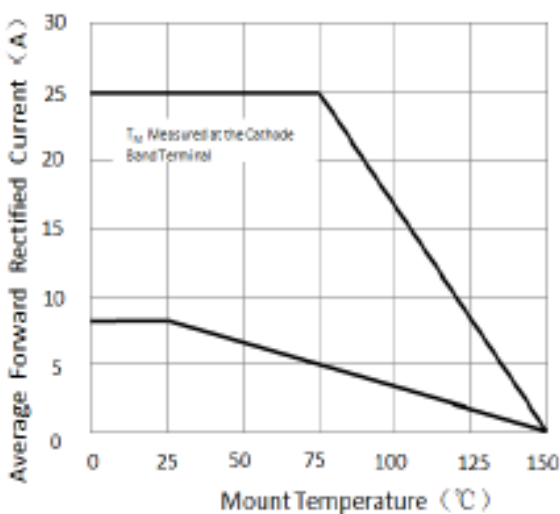
**Figure 2. Typical Reverse Characteristics**



**Figure 3. Typical Junction Capacitance**



**Figure 4. Typical Instantaneous Forward Characteristics**

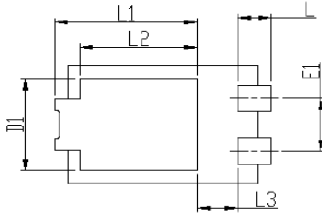
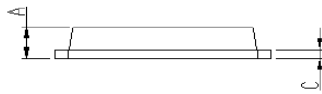
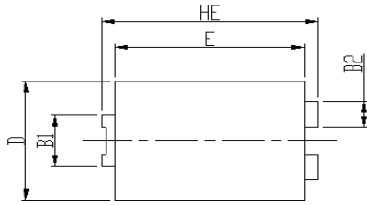


**Figure 5. Forward Current Derating Curve**

## Package Outline Dimensions

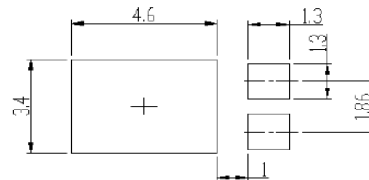
in inches (millimeters)

### eSGC (TO-277B)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
HE	6.4	6.6	0.252	0.260
E	5.6	5.8	0.220	0.228
D	4.1	4.3	0.161	0.169
B1	1.7	1.9	0.067	0.075
B2	0.8	1	0.031	0.039
A	1.05	1.2	0.041	0.047
C	0.3	0.4	0.012	0.016
L	0.85	1.1	0.033	0.043
L1	4.2	4.4	0.165	0.173
L2	3.52 Typ.		0.139 Typ.	
L3	1.1	1.4	0.043	0.055
D1	3	3.3	0.118	0.130
E1	1.86 Typ.		0.073 Typ.	

Soldering footprint



## Revision History

Document Version	Date of release	Description of changes
Rev.A	2021.06.01	Released Datasheet
Rev.B	2023.10.11	Modify document format
Rev.C	2023.12.29	Modify package name

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